

Item No.	Reference	Qty	Value	Part Number	Manufacturer	Description	Packaging	Typical Dimensions in mm (inches)
1	IC1	1	—	TLP3906	Toshiba	Photovoltaic-output photocoupler	SO6	3.7×7.0
2	Q1	1	—	TPH1R306PL	Toshiba	MOSFET	SOP Advance	5.0×6.0
3	R1	1	200Ω	—	—	0.1W, ±5%	1608	1.6 x 0.8 (0603)

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